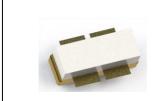
## Gallium Nitride 28V 160W, C band RF Power Transistor

### **Description**

The XTAH50160F4C is a 160W internally matched, GaN HEMT, designed from 4.4 to 5.0GHz, especially 5G NR or LTE application, as well as either Pulse or CW application. There is no guarantee of performance when this part is used in applications designed Outside of these frequencies.

XTAH50160F4C



Typical CW performance (on 4.4-5.0GHz fixture with device soldered):

Vds=28V, I<sub>DQ</sub>=200mA, Tc=25 °C

Freq	P1dB	P1dB	P1dB	P1dB	P3dB	P3dB	P3dB
(MHz)	(dBm)	(W)	Eff(%)	Gain(dB)	(dBm)	(W)	Eff(%)
4400	51.28	134.3	47.1	9.93	52.19	165.5	48.2
4500	51.43	139.0	47.8	10.52	52.43	175.0	49.3
4600	51.55	142.8	48.9	10.93	52.62	182.6	50.8
4700	51.61	144.9	50.9	11.26	52.8	190.4	53.3
4800	51.38	137.5	51.4	11	52.64	183.8	54.4
4900	51.01	126.1	52.3	10.71	52.33	171.1	55.8
5000	50.62	115.3	53.0	10.35	52.20	165.9	56.3

Recommended driver: GTAH58030GX

### **Applications and Features**

- Suitable for wireless communication infrastructure, wideband amplifier, EMC testing, ISM etc.
- High Efficiency and Linear Gain Operations
- Thermally Enhanced Industry Standard Package
- High Reliability Metallization Process
- Excellent thermal Stability and Excellent Ruggedness
- Compliant to Restriction of Hazardous Substances (RoHS) Directive 2002/95/EC

#### **Important Note: Proper Biasing Sequence for GaN HEMT Transistors**

#### Turning the device ON

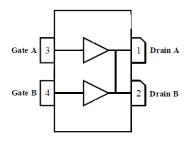
- 1. Set VGS to the pinch--off (VP) voltage, typically –5 V
- 2. Turn on VDS to nominal supply voltage (28V)
- 3. Increase VGS until IDS current is attained
- 4. Apply RF input power to desired level

#### Turning the device OFF

- 1. Turn RF power off
- 2. Reduce VGS down to VP, typically -5 V
- 3. Reduce VDS down to 0 V
- 4. Turn off VGS

Figure 1: Pin definitions (Top view)

Because of internal configuration, it must be used as single ended device.



**Table 1. Maximum Ratings** 

Rating	Symbol	Value	Unit
DrainSource Voltage	V <sub>DSS</sub>	150	Vdc
GateSource Voltage	$V_{GS}$	-10,+2	Vdc
Operating Voltage	$V_{DD}$	36	Vdc
Maximum Forward Gate Current @ Tc = 25°C	Igmax	43.6	mA
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	Tc	+150	°C
Operating Junction Temperature(See note 1)	TJ	+225	°C
Total Device Power Dissipation (Derated above 25°C, see note 2)	Pdiss	260	W

Note: 1. Continuous operation at maximum junction temperature will affect MTTF

#### **Table 2. Thermal Characteristics**

Characteristic	Symbol	Value	Unit	
Thermal Resistance, Junction to Case	Pale	0.7	CAM	
T <sub>C</sub> = 85°C, T <sub>J</sub> =200°C, RF CW operation	Rejc	0.7	C/W	

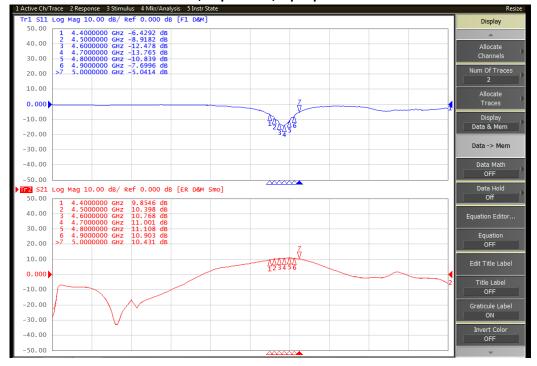
**Table 3. Electrical Characteristics** (T<sub>C</sub> = 25 <sup>o</sup>C unless otherwise noted)

#### **DC Characteristics**

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	oltage V <sub>GS</sub> =-8V; I <sub>DS</sub> =43.6mA		150			V
Gate Threshold Voltage V <sub>DS</sub> = 28V, I <sub>D</sub> =43.6mA		V <sub>GS</sub> (th)	-4		-2	V
Gate Quiescent Voltage  V <sub>DS</sub> =28V, I <sub>DS</sub> =200mA,  Measured in Functional Test		V <sub>GS(Q)</sub>		-2.5		V

## **Typical performance**

Figure 2: Small singal gain and return loss Vs Frequency Vds=28V, Idq=300mA, input power=0dBm



<sup>2.</sup>Bias Conditions should also satisfy the following expression: Pdiss < (Tj - Tc) / RJC and Tc = Tcase

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Figure 3:Power gain, Efficiency as function of output power

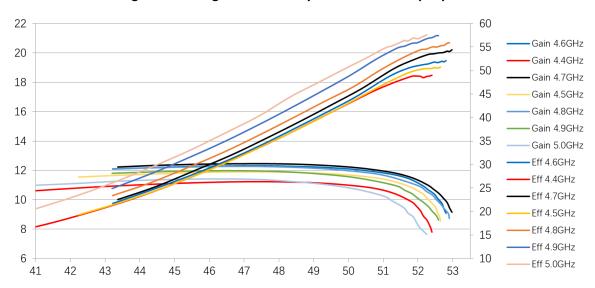
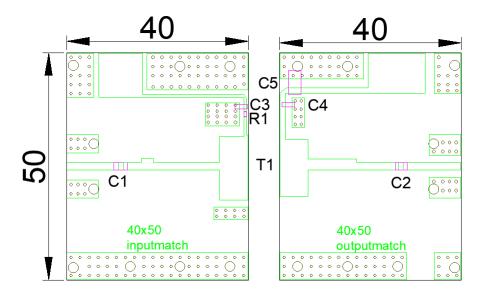


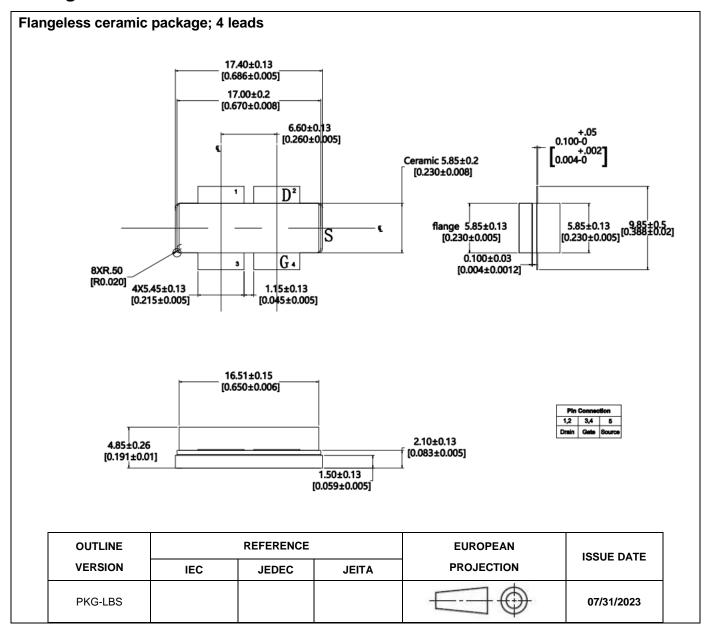
Figure 3: Picture and Bill of materials of wide band application circuit (Layout Gerber file upon request)



Part	Quantity	Description	Part Number	Manufacture
C1,C2,C3,C4	4	3.9pFHigh Q	251SHS3R9BSE	TEMEX
		Capacitor		
C5	1	10uF MLCC	GRM32EC72A106M	Murata
			E05	
R1	1	10Ω Power	ESR03EZPF100	ROHM
		Resistor		
T1	1	120W GaN	XTAH50160F4C	Innogration
		Dual Transistor		

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## **Package Outline**



## **Revision history**

Table 4. Document revision history

Date	Revision	Datasheet Status
2025/2/9	V1.0	Advanced Datasheet Creation with Vth variation to be fixed

Application data based on LWH-25-02